

Features

- Lead free
- RoHS compliant*
- Multiple resistors tied to a common node
- Stable thin-film-on-silicon technology
- Ultra-miniature packages to JEDEC standards



Applications

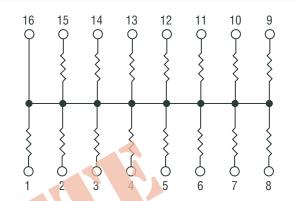
- Bus termination
- Pull-up/pull-down
- Ideal for space-constrained applications

Thin Film on Silicon 2QSP / 2NBS-XX2 Bussed Resistors

General Information

Bussed Resistor networks are typically used in DC pull-up and pull-down applications where system data or control lines must be tied to a fixed potential. Fabricated with a Tantalum Nitride and Nickel Chromium on Silicon process, these resistors feature excellent stability, TCR and tracking performance. Bussed Resistor Networks are available in a range of miniature package types conforming to JEDEC standards.

Package Schematic



Electrical & Environmental Characteristics

Electrical Characteristics	Symbol	Minimum	Nominal	Maximum	Unit
Resistance Range	R	100		100 K	Ω
Tolerance:	2 1 1				
Absolute		±0.5 %		±5 %	Ω
Ratio		±0.1 %		±2 %	Ω
TCR: Absolute Tracking			100	150 25	ppm/°C ppm/°C
Operating Voltage				50	V
Environmental Characteristics					
ESD		2 K			V
Operating Temperature	TJ	-55		+125	°C
Storage Temperature	T _{stg}	-65		+150	°C
Power Rating per Resistor @ 70 °C				0.1	Watt
Power Rating per Package @ 70 °C: QSOP: 16 Pin 20, 24 Pin 28 Pin				0.75 1.00 1.12	Watt Watt Watt
NBSOIC: 8 Pin 14, 16 Pin				0.60 1.00	Watt Watt

^{*}RoHS Directive 2002/95/EC Jan 27, 2003 including Annex

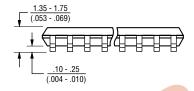
Thin Film on Silicon 2QSP / 2NBS -XX2 Bussed Resistors

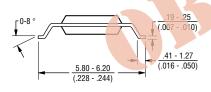
BOURNS®

Mechanical Characteristics

QSOP Package Dimensions

3.81 - 3.99 (.150 - .157) PIN 1 .21 - .31 (.008 - .012)



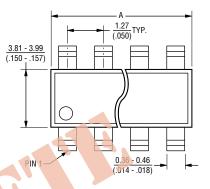


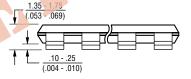
Model	A			
2QSP16	4.80 - 4.98 (.189196)			
2QSP20	8.56 - 8.74 (.337344)			
2QSP24	8.56 - 8.74 (.337344)			
2QSP28	9.80 - 9.98 (.386393)			

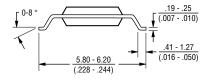
Governing dimensions are in mm. Dimensions in parentheses are in inches and are approximate.

JEDEC Reference Number MO-137.

Narrow-Body SOIC Package Dimensions







Model	Α			
2NBS08	4.80 - 4.98 (.189196)			
2NBS14	8.56 - 8.74 (.337344)			
2NBS16	9.80 - 9.98 (.386393)			

Governing dimensions are in mm. Dimensions in parentheses are in inches and are approximate.

JEDEC Reference Number MS-012.

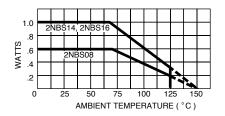
Thin Film on Silicon 2QSP / 2NBS -XX2 Bussed Resistors

BOURNS®

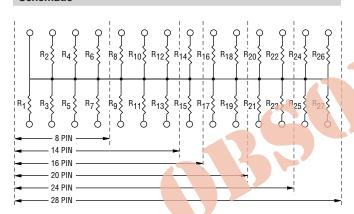
QSOP Package Power Temperature Derating Curve

1.25 2QSP28 1.0 2QSP20, 2QSP24 2QSP16 25 50 75 100 125 150 AMBIENT TEMPERATURE (°C)

Narrow-Body SOIC Package Power Temperature Derating Curve



Schematic

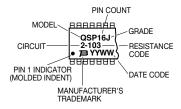


Standard Resistance Values

Resistance (ohms)	Resistance Code
100	101
120	121
220	221
270	271
330	331
390	391
470	471
510	511
680	681
1 K	102
1.5 K	152
2 K	202
2.2 K	222
2.7 K	272
3.3 K	332
4.7 K	472
5.1 K	512
10 K	103
20 K	203
27 K	273
47 K	473
51 K	513
75 K	753
82 K	823
100 K	104

Typical Part Marking

Represents total content. Layout may vary.

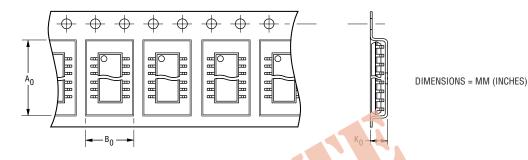


Thin Film on Silicon 2QSP / 2NBS -XX2 Bussed Resistors

BOURNS

Dispensing

For large quantities, the product will be dispensed in Tape and Reel (see diagram below).



Package	Α ₀	В0	K ₀	Width	Pitch	No. of Pieces	No. of Pieces
QSOP						poi 10 100i	por tabe
16 Pin	6.4 (0.252)	5.2 (0.205)	2.1 (0.083)	12 (0.472)	8 (0.315)	3,500	98
20, 24 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	56
28 Pin	6.5 (0.256)	10.3 (0.406)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	49
NBSOIC							
8 Pin	6.4 (0.252)	9.0 (0.354)	2.1 (0.083)	12 (0.472)	8 (0.315)	3,500	98
14 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	56
16 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	49

Product Class Thin-Film-on-Silicon Standard Package Style QSP = QSOP NBS = Narrow-Body SOIC Pin Count QSP = 16, 20, 24, 28 NBS = 8, 14, 16 Dispensing R = Reel T = Tube Standard Grade Tolerance J = ±5 % G = ±2 % F = ±1 % Circuit 2 = Bussed Resistance Value Code 1st two digits are significant, 3rd digit = number of zeros to follow to give resistance value in ohms. Terminations LF = 100 % Sn (lead free)



Asia-Pacific:

Tel: +886-2 2562-4117 • Fax: +886-2 2562-4116

Europe:

Tel: +41-41 768 5555 • Fax: +41-41 768 5510

The Americas:

Tel: +1-951 781-5500 • Fax: +1-951 781-5700

www.bourns.com